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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/587,315	07/26/2006	Hiroshi Yamada	01197.0276	4548
	7590 03/21/2008 HENDERSON, FARABOW, GARRETT & DUNNER		EXAMINER	
LLP 901 NEW YORK AVENUE, NW			VAUGHAN II, JUAN E	
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)	
	10/587,315	YAMADA ET AL.	
Office Action Summary	Examiner	Art Unit	
	JUAN E. VAUGHAN II	1795	
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet with the c	correspondence address	
A SHORTENED STATUTORY PERIOD FOR REPLEWHICHEVER IS LONGER, FROM THE MAILING DEVELOPMENT OF THE MAILING	DATE OF THIS COMMUNICATION .136(a). In no event, however, may a reply be tind d will apply and will expire SIX (6) MONTHS from te, cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).	
Status			
Responsive to communication(s) filed on 26 € 2a) This action is FINAL . 2b) This 3) Since this application is in condition for allowed closed in accordance with the practice under	is action is non-final. ance except for formal matters, pro		
Disposition of Claims			
4) Claim(s) 1-20 is/are pending in the application 4a) Of the above claim(s) is/are withdra 5) Claim(s) is/are allowed. 6) Claim(s) 1-20 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/o	awn from consideration. or election requirement. er.		
10) The drawing(s) filed on is/are: a) ac Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E	e drawing(s) be held in abeyance. Section is required if the drawing(s) is ob-	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreig a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureat* * See the attached detailed Office action for a list	nts have been received. nts have been received in Applicationity documents have been received au (PCT Rule 17.2(a)).	on No ed in this National Stage	
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date See Continuation Sheet.	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal F 6) Other:	ate	

 $Continuation \ of \ Attachment(s)\ 3).\ Information \ Disclosure \ Statement(s)\ (PTO/SB/08),\ Paper\ No(s)/Mail\ Date \ :07/26/07;09/24/07;11/28/07;12/17/07.$

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DETAILED ACTION

1. This is the initial Office Action for the Photosensitive Resin Composition For Printing Substrate Capable of Laser Sculpture application filed January 26, 2005.

Priority

2. Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

Claim Rejections - 35 USC § 102/35 USC § 103

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:
 - 1. Determining the scope and contents of the prior art.
 - 2. Ascertaining the differences between the prior art and the claims at issue.
 - 3. Resolving the level of ordinary skill in the pertinent art.
 - 4. Considering objective evidence present in the application indicating obviousness or nonobviousness.
- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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6. Claims 1-20 are rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over ISHIZUKA et al. (US 2003/0224281 A1).

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- a. ISHIZUKE et al. disclose a planographic printing plate precursor containing a photosensitive composition. With respect to claim 1, ISHIZUKE et al. disclose a phenol resin (resin) having a urea bond (polymerizable unsaturated group) in the main chain (abstract). The phenol resin, represented by general formula (A), has a number molecular weight of 500 or more ([0065]). The photosensitive composition also includes an ethylenically unsaturated compound (organic compound) ([0068]. Examples given for the ethylenically unsaturated compound and meeting the limitations of the organic compound (b) include monofunctional (meth)acrylates, urethane acrylates, polyester acrylates, and epoxy acrylates. Theses examples include preferable examples in paragraphs [0063-0064] of present application, and therefore meet the limitation of a molecular weight less than 1000. Further disclosed is the phenol resin containing a silyl ether (organic silicone compound) ([0048]). Based on general formula (A) ([0065]) and the teaching of the phenol resin being present in the amount of 5 to 95% of the photosensitive composition ([0067]), including the silvl ether is present within the range of 0.1-10 wt % of the photosensitive resin composition.
- b. With respect to claims 2 and 3, the organosilane of ISHIZUKE et al., represented by $-(OR)_m$ when R equals $-Si(R'')_3$, R'' is a monovalent organic group, and m is 1, meets the limitations of formula (1) in present application when in formula (1) of present application R equals 3 cycloalkyl groups, p is 2, r is 0, and x is 0 ([0066]). Thus, as it relates to claim 2, when structures are substantially identical to that of the claims, claimed

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properties are presumed to be inherent. (MPEP 2112.01) Because the silyl ether of ISHIZUKE et al. meets the limitations of formula (1) of present application, silyl ether will also be liquid at 20°C.

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- c. With respect to claims 4, 5 and, 6, in reactions (II) through (X) disclosed by ISHIZUKE, the silyl ether of the phenol resin is represented by –(OSi(R")₃) (page 4) and R" is a hydrocarbon having one or more substituents which may be an aryl group as claimed ([0059]). As it relates to claim 5, the substituents of R" may also be a methyl group with substituents, which meets the limitation of a carbinol when the subsituent is –OH ([0061]).
- d. With respect to claims 7-10, ISHIZUKE et al. disclose the use of two or more radical polymerization initiators ([0099]). The initiators include acetophenone compounds, meeting the limitation of degradable polymerization initiators, and benzophenone compounds, meeting the limitation of hydrogen extraction polymerization initiators ([0099]). Acetophenone compounds also meet the limitations of compounds having a site functioning as a hydrogen extraction photopolymerization initiator and a site functioning as the degradable photopolymerization initiator as disclosed in claim 10.

 e. With respect to claim 11, because the phenol resin of ISHIKUZE et al. meets the limitations of the resin of present application, the phenol resin will also be liquid at 20°C. When structures are substantially identical to that of the claims, claimed properties are presumed to be inherent. (MPEP 2112.01) Additionally, the addition-polymerizable ethylenically compound (organic compound (b) comprises 2 or more unsaturated groups including urethane acrylates (urethane bond) and polyester acrylates (ester bonds).

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f. With respect to claim 13, as discussed above in reference to claim 11 and as disclosed in present application ([0061]), when the resin is a liquid at 20°C, the photosensitive resin composition is also liquid at 20°C.

- 7. Claims 12 and 14-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over ISHIZUKA et al. (US 2003/0224281 A1).
 - a. With respect to claim 12, ISHIKUKE et al. teaches the coating solution (coating layer) applied in amounts of 10 to 100 mL/m² ([0154]). Because the photosensitive composition of ISHIKUZE et al. meets the limitations of the photosensitive composition of present application, any range of the coating layer thickness would be an optimization thereof. (MPEP 2144.05) The amount of coating solution directly affects the coating layer thickness. The coating layer thickness is therefore optimizable.

Further, ISHIKUKZE does not appear to disclose a photosensitive resin composition having a haze and would therefore meet the limitation of having a photosensitive resin composition having a haze of 0 to 70%.

b. With respect to claims 14, ISHIZUKE et al. disclose a planographic printing plate substrate (laser engravable printing substrate) coated with a coating solution prepared by dissolving the photosensitive composition in an organic solvent ([0141,0149]). Based on general formula (A) ([0065]) and the teaching of the phenol resin being present in the amount of 5 to 95% of the photosensitive composition ([0067]), it is obvious to one of ordinary skill in the art that the silyl ether is present within the range of 0.1-10 wt % of the photosensitive resin composition.

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c. With respect to claims 15-18, the substrate is subjected to surface treatment including ball polishing (polishing processing) and sand blasting (blast processing) as claimed in claim 16 of present application ([0144]). Because the substrate of ISHIKUZE et al. meets the limitations of the substrate as claimed in present application and claims 15-18 use product by process language and intended use language including "obtained by", "detected and quantitatively determined using", "by applying", "by application of", and "which can be engraved using" the claims (15-18) are unpatentable. Patentability of a product does not depend on its method of production. (MPEP 2113)

d. With respect to claim 20, the substrate of ISHIKUZE et al. is a planographic printing plate (letterpress printing original plate) having an image formed by exposing the photosensitive layer to light (laser engraving process).

Conclusion

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to JUAN E. VAUGHAN II whose telephone number is (571)270-5125. The examiner can normally be reached on Monday - Friday 8AM-5PM EST.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Cynthia H. Kelly can be reached on (571)272-1526. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated

information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

JEV II

/Cynthia H Kelly/ Supervisory Patent Examiner, Art Unit 1795